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Atty. Docket No. CPAC.1001-1 (formerly 60084-300101)  
Appl. No. 09/802,443

PATENT



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Rajendra D. PENDSE, *et al.*

Application No.: 09/802,443

Filed: March 9, 2001

Title: **Flip chip-in-leadframe package and process**

) Examiner: *Unknown*

) Group Art Unit: *2811*

) Date: 19 September, 2001

) CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231 on

19 September, 2001.

Signed

*Linda Shaw*  
Linda Shaw

COMMISSIONER OF PATENTS  
WASHINGTON, D.C. 20231

**REVOCATION OF PREVIOUS POWERS OF ATTORNEY  
AND APPOINTMENT OF NEW ATTORNEY BY ASSIGNEE  
TO EXCLUSION OF INVENTORS UNDER 37 CFR 3.71,  
WITH STATEMENT UNDER 37 CFR 3.73(b)**

Sir:

ChipPAC, Inc. is the ASSIGNEE of the entire right, title and interest in and to the above-identified patent application. Marcos Kamezos, undersigned, Chief Technology Officer of ChipPAC, Inc., is an individual authorized and empowered to sign the Power of Attorney and Revocation of Previous Powers on behalf of the ASSIGNEE.

The undersigned ASSIGNEE of the entire interest in the above-identified application for letters patent hereby appoints:

Mark A. Haynes	- Reg. No. 30,846
Ernest J. Beffel, Jr.	- Reg. No. 43,489
Warren S. Wolfeld	- Reg. No. 31,454
James F. Hann	- Reg. No. 29,719
Bill Kennedy	- Reg. No. 33,407

to prosecute this application and transact all business in the United States Patent and Trademark Office in connection therewith and hereby revokes all previous powers of attorney; said appointment to be to the exclusion of the inventors and the inventors' attorneys in accordance with the provisions of 37 C.F.R. § 3.71.

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The following evidentiary documents establish a chain of title from the original owner to the Assignee:

- ☒ a copy of an Assignment attached hereto, which Assignment has been (or is herewith) forwarded to the Patent and Trademark Office for recording; or
- ☐ a copy of the Assignment recorded on \_\_\_\_\_ at reel , frames \_\_\_\_\_ - \_\_\_\_\_.

Pursuant to 37 C.F.R. § 3.73(b) the undersigned ASSIGNEE hereby states that the evidentiary documents have been reviewed and hereby certifies that, to the best of ASSIGNEE's knowledge and belief, title is in the identified ASSIGNEE.

Direct all telephone calls to Bill Kennedy at (650) 712-0340.

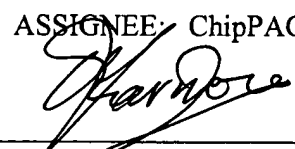
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ASSIGNEE: ChipPAC, Inc.

Signature: \_\_\_\_\_

  
Marcos Karnezos  
Chief Technology Officer  
ChipPAC, Inc.

Date: \_\_\_\_\_

*September 13, 2001*